

### 1N4007GR

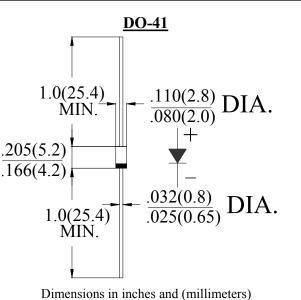
#### **1.0AMP . GLASS PASSIVATED RECTIFIERS**

#### FEATURE

- . High current capability
- . Low forward voltage drop
- . Low power loss, high efficiency
- . High surge capability
- . High temperature soldering guaranteed 260°C /10sec/ 0.375" lead length at 5 lbs tension

### **MECHANICAL DATA**

- . Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
- . Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
- . Polarity: color band denotes cathode
- . Mounting position: any



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at  $25^{\circ}$ C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

Type Number	SYM BOL	1N4007GR	units	
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	1000	V	
Maximum RMS Voltage	V <sub>RMS</sub>	700	V	
Maximum DC blocking Voltage	VDC	1000	V	
Maximum Average Forward Rectified Current .375"(9.5mm) lead length	I <sub>F(AV)</sub>	1.0	A	
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>	30.0	А	
Maximum Forward Voltage at 1.0A DC	VF	1.0	V	
Maximum DC Reverse Current@T <sub>J</sub> =25°Cat rated DC blocking voltage@T <sub>J</sub> =125°C	I <sub>R</sub>	5.0 100.0	μΑ	
Typical Junction Capacitance (Note 1)	CJ	8	pF	
Territed Thermol Desistence (Math 2)	<b>R</b> (JA)	75	°C/W	
Typical Thermal Resistance (Note 2)	R <sub>(JC)</sub>	25		
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C	
Operation Junction Temperature	TJ	-55 to +150	°C	

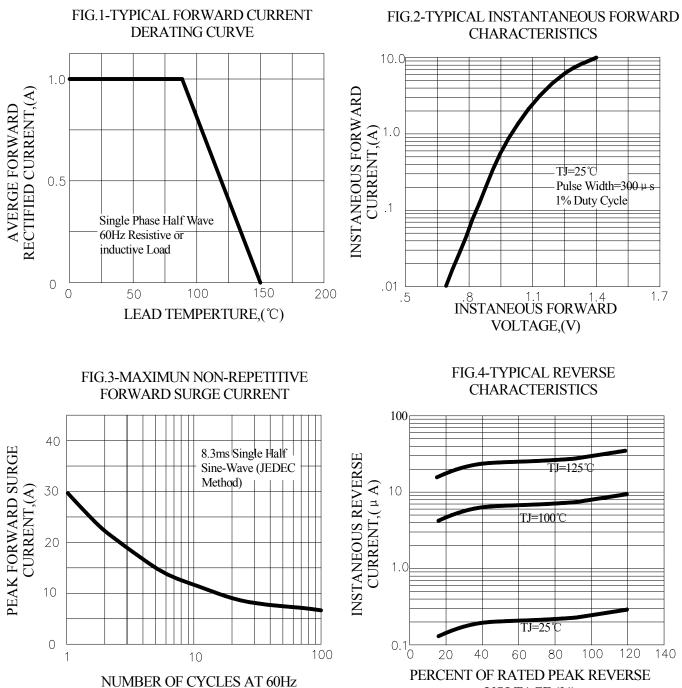
#### Note:

1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc

2. Thermal Resistance from Junction to Ambient at 0.375" (9.5mm) lead length, vertical P.C.Board Mounted.



#### RATING AND CHARACTERISTIC CURVES (1N4007GR)

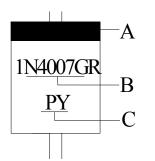


VOLTAGE,(%)



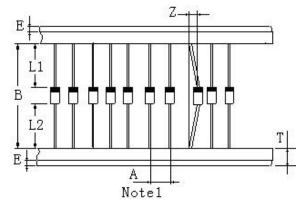
## Marking and packaging illustration

## 1. Marking



SYMBOL	Explanation		
Α	<b>Color Band Denotes Cathode</b>		
В	Product Name		
С	Trademark		

## 2、Packaging



ITEM	SYMBOL	SPECIFICATIONS	SPECIFICATIONS	
		(mm)	(inch)	
Component alignment	Z	1.2max	0.048max	
Tape width	Т	6.0±0.4	0.236±0.016	
Exposed adhesive	Е	0.8max	0.032max	
Body eccentricity	L1-L2	1.0max	0.040max	
Component	A	5.0±0.5	0.2±0.02	
Inner tap	В	52.0~53.5	2.05~2.11	
NOTE:				
Each component lead shall be sandwiched between tapes for a minimum of 2.5mm (0.1inch)				

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